# **GP1S95**

### **■** Features

1. Compact package (3.6×3.4×4.7mm)

2. Gap width: 1.6mm

3. Slit width (detector side): 0.3mm

# ■ Applications

1. DVD players

2. CD-ROM drivers

3. Floppy disk drivers

■ Absolute Maximum Ratings

 $(Ta=25^{\circ}C)$ 

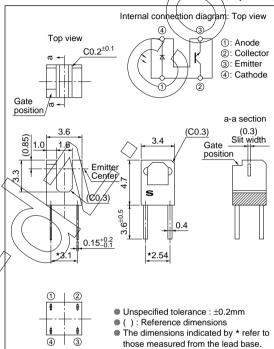
	Parameter	Symbol	Rating	Unit	
Input	Forward current	IF	50	mA	
	Reverse voltage	VR	6	V	
	Power dissipation	P	75	mW	
Output	Collector-emitter voltage	Vceo	35	V	
	Emitter-collector voltage	VECO	Veco 6		
	Collector current	Ic	20	mA	
	Collector power dissipation	Pc	75	mW	
Total power dissipation		Ptot	100	mW <	
	Operating temperature	Topr	-25 to +85	°C)	
	Storage temperature	Tstg	-40 to +100	/ %C	
*1 Soldering temperature		Tsol	260	(°C	

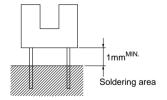
<sup>\*1</sup> For 5s or less

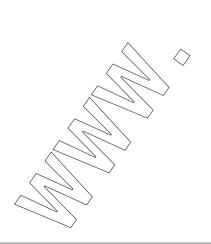


## **■** Outline Dimensions









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Internet address for Electronic Components Group http://www.sharp.co.jp/ecg/

Electro-o	ptical	Characte	eristics

■ Elec	ctro-optic	al Chara	acteristi	cs			(Ta=25°C)
Parameter			Symbol	Conditions	MIN.	TYP.	MAX Unit
Input	Forward voltage		V <sub>F</sub>	I <sub>F</sub> =20mA	-	1.2	1.4 V
	Reverse current		Ir	V <sub>R</sub> =3V	_	-	10 µA
Output	t Collector dark current		Iceo	Vce=20V	-	-	100 nA
Transfer characteristics	Collector current		Ic	Vce=5V, I <sub>F</sub> =5mA	50	- /	300 µA
	Response time	Rise time	tr	Vce=5V, Ic=100μA	_	35 /	100 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
		Fall time	<b>t</b> f	$R_L=1~000\Omega$	_	35 \	100) µs
	Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	$I_F=10\text{mA}, I_C=50\mu\text{A}$	_	- \	0.4 / V

Fig.1 Forward Current vs. Ambient **Temperature** 

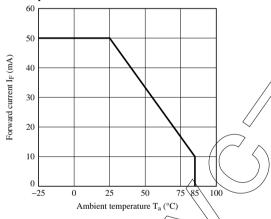


Fig.3 Forward Current vs. Forward Voltage

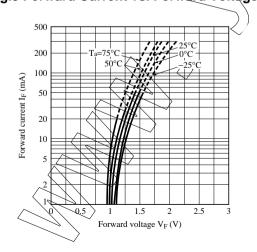


Fig.2 Power Dissipation vs. Ambient

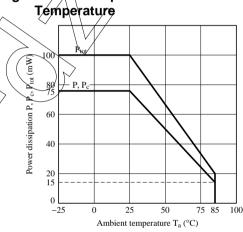


Fig.4 Collector Current vs. Forward Current

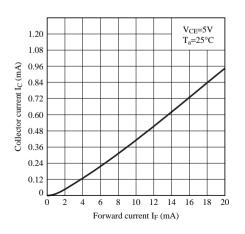


Fig.5 Collector Current vs. Collector-emitter Voltage

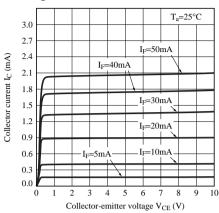


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

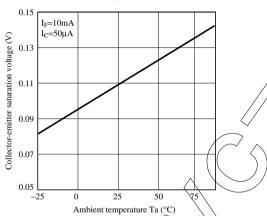


Fig.9 Response Time vs. Load Resistance

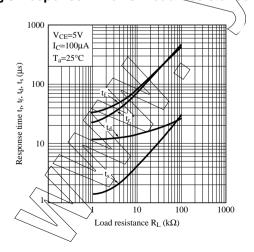


Fig.6 Relative Collector Current vs.

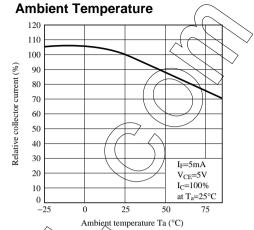


Fig.8 Collector Dark Current vs. Ambient Temperature

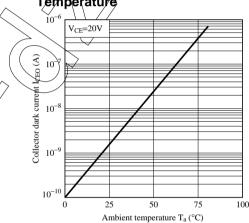
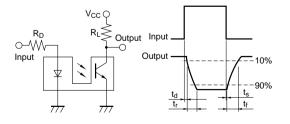


Fig.10 Test Circuit for Response Time



**SHARP** Fig.12 Relative Collector Current vs. Shield Fig.11 Relative Collector Current vs. Shield Distance (2) (Typical Value) **Distance (1) (Typical Value)** 100 100 Relative collector current (%) Relative collector current (%) Shield distance 90 90 80 80 Shield I<sub>F</sub>=5.0mA I<sub>F</sub>=5.0mA 60 60  $V_{CE}=5V$   $T_a=25$ °C  $V_{CE}=5V$   $T_a=25$ °C 50 50 40 40 20 20 10 10 -1 3 3 Shield distance L (mm) Shield distance L (mm)

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